

N-channel 80 V 11 m Ω standard level MOSFET

Rev. 02 — 25 June 2009

Product data sheet

1. Product profile

1.1 General description

Standard level N-channel MOSFET in TO220 package qualified to 175 °C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

High efficiency due to low switching and conduction losses

1.3 Applications

- DC-to-DC converters
- Load switching

1.4 Quick reference data

 Suitable for standard level gate drive sources

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- Motor control
- Server power supplies

Table 1.	Quick reference						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C		-	-	80	V
I _D	drain current	$T_{mb} = 25 \text{ °C}; V_{GS} = 10 \text{ V};$ see <u>Figure 1</u>		-	-	74	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>		-	-	148	W
Dynamic	characteristics						
Q _{GD}	gate-drain charge	$\label{eq:V_GS} \begin{array}{l} V_{GS} = 10 \text{ V}; \ I_D = 25 \text{ A}; \\ V_{DS} = 40 \text{ V}; \ see \ \underline{Figure \ 14}; \\ see \ \underline{Figure \ 15} \end{array}$		-	9.4	-	nC
Static ch	aracteristics						
R _{DSon}	drain-source on-state resistance	V_{GS} = 10 V; I _D = 15 A; T _j = 25 °C;	[1]	-	9	11	mΩ

[1] Measured 3 mm from package.

N-channel 80 V 11 m Ω standard level MOSFET

2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		_
2	D	drain	mb	
3	S	source		
3 mb	D	mounting base; connected to drain		mbb076 S
			SOT78	

(TO-220AB; SC-46)

3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
PSMN012-80PS	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78		

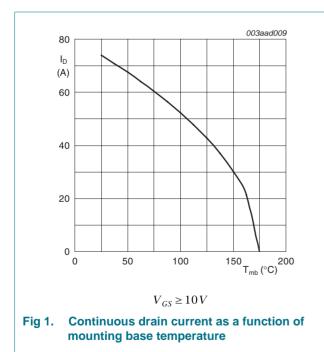
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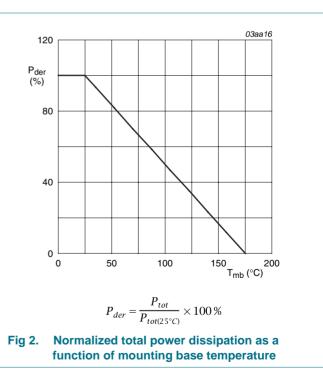
4. Limiting values

Table 4.Limiting values

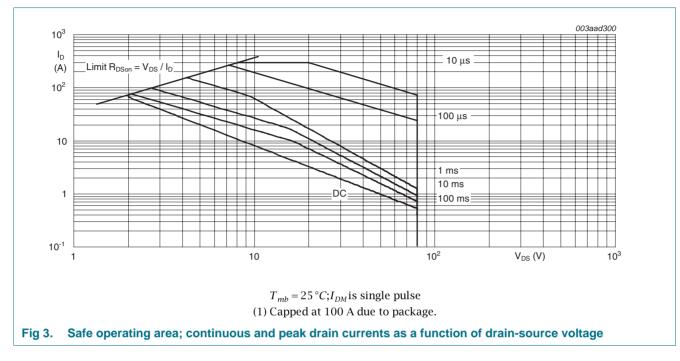
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	80	V
V _{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$	-	80	V
V _{GS}	gate-source voltage		-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u>	-	52	А
		V_{GS} = 10 V; T_{mb} = 25 °C; see <u>Figure 1</u>	-	74	А
I _{DM}	peak drain current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$; see Figure 3	-	295	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	148	W
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
Source-dr	ain diode				
I _S	source current	T _{mb} = 25 °C	-	74	А
I _{SM}	peak source current	$t_p \le 10 \ \mu s$; pulsed; $T_{mb} = 25 \ ^{\circ}C$	-	295	А
Avalanche	e ruggedness				
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 74 A; V_{sup} \leq 80 V; R_{GS} = 50 $\Omega;$ unclamped	-	100	mJ





N-channel 80 V 11 mΩ standard level MOSFET



5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j-mb)}$	thermal resistance from junction to mounting base	see Figure 4	-	0.65	1	K/W

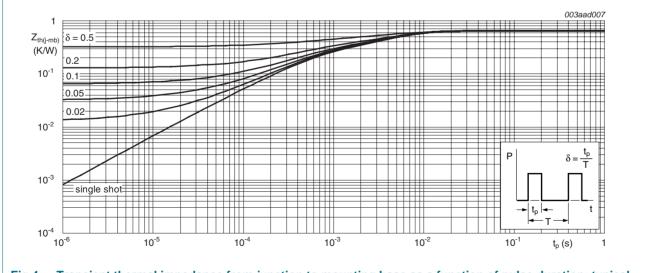


Fig 4. Transient thermal impedance from junction to mounting base as a function of pulse duration; typical values

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6. Characteristics

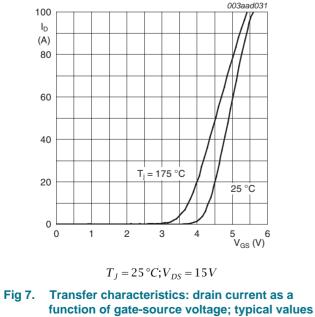
Table 6.	Characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	aracteristics						
V _{(BR)DSS}	drain-source	I_D = 250 µA; V_{GS} = 0 V; T_j = -55 °C		73	-	-	V
	breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C		80	-	-	V
V _{GS(th)} gate-source th voltage	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		-	-	4.6	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see <u>Figure 11</u> ; see <u>Figure 12</u>		2	3	4	V
I _{DSS}	drain leakage current	$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	3	μA
		$V_{DS} = 80 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ °C}$		-	-	60	μA
I _{GSS}	gate leakage current	V_{GS} = -20 V; V_{DS} = 0 V; T_j = 25 °C		-	-	100	nA
		$V_{GS} = 20 \text{ V}; V_{DS} = 0 \text{ V}; T_j = 25 \text{ °C}$		-	-	100	nA
R _{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 15 A; T _j = 100 °C; see <u>Figure 13</u>		-	-	18	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C	[2]	-	9	11	mΩ
R _G	internal gate resistance (AC)	f = 1 MHz		-	0.97	-	Ω
Dynamic	characteristics						
Q _{G(tot)}	total gate charge	$I_D = 0 \text{ A}; V_{DS} = 0 \text{ V}; V_{GS} = 10 \text{ V}$		-	36	-	nC
		$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$ see <u>Figure 14</u> ; see <u>Figure 15</u>		-	43	-	nC
Q _{GS}	gate-source charge	$I_D = 25 \text{ A}; V_{DS} = 40 \text{ V}; V_{GS} = 10 \text{ V};$		-	12	-	nC
$Q_{GS(th)}$	pre-threshold gate-source charge	see <u>Figure 14;</u> see <u>Figure 15</u>		-	8	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge			-	4	-	nC
Q _{GD}	gate-drain charge			-	9.4	-	nC
V _{GS(pl)}	gate-source plateau voltage	$V_{DS} = 40 V$		-	4.5	-	V
C _{iss}	input capacitance	V _{DS} = 12 V; V _{GS} = 0 V; f = 1 MHz;		-	2782	-	pF
C _{oss}	output capacitance	$T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure } 16}{100}$		-	384	-	рF
C _{rss}	reverse transfer capacitance			-	162	-	pF
t _{d(on)}	turn-on delay time	V_{DS} = 12 V; R_{L} = 0.5 Ω; V_{GS} = 10 V;		-	19	-	ns
t _r	rise time	$R_{G(ext)} = 4.7 \Omega$		-	16	-	ns
t _{d(off)}	turn-off delay time			-	33	-	ns
t _f	fall time			-	6	-	ns

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Symbol	Characteristicscontin	Conditions		Min	Тур	Max	Unit
	rain diode	Conditions		141111	тур	IVIAN	Unit
/ _{SD}	source-drain voltage	$I_S = 25 \text{ A}; V_{GS} = 0 \text{ V}; T_j =$ see <u>Figure 17</u>	= 25 °C;	-	0.86	1.2	V
r	reverse recovery time	$I_{\rm S} = 50 \text{ A}; \text{ dI}_{\rm S}/\text{dt} = 100 \text{ A}$	/µs; V _{GS} = 0 V;	-	45	-	ns
ک _r	recovered charge	$V_{DS} = 40 V$		-	64	-	nC
] Tested	to JEDEC standards where a	pplicable.					
] Measur	red 3 mm from package.						
		003aad029				003aad030	
250 I _D	10	$V_{GS}(V) = 15$	25 5	5.5 6	1 11	10	
(A)	7		R _{DSon} (mΩ)		AAA		
200	6.5		20				
		6			M		
150							
		5.5	15				
100							
100		5					
			10				
50		4.5	V _{GS} (V	/) = 15			
0	0 2 4 6	8	5 50	100	150 2	00 25	0
· · · · ·		8 V _{DS} (V) ¹⁰				I _D (A)	
	$T_j = 25 ^{\circ}C; t_p = 3$	00 µs		$T_j = 25 \circ C; t_p$	= 300µs		
	Output characteristics: d			irce on-state			unctior
f	unction of drain-source	voltage; typical values	of drain c	urrent; typica	al values	;	
		003aad031				003aad035	
100			4000			003440035	



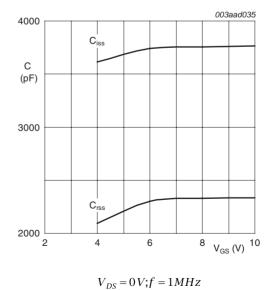


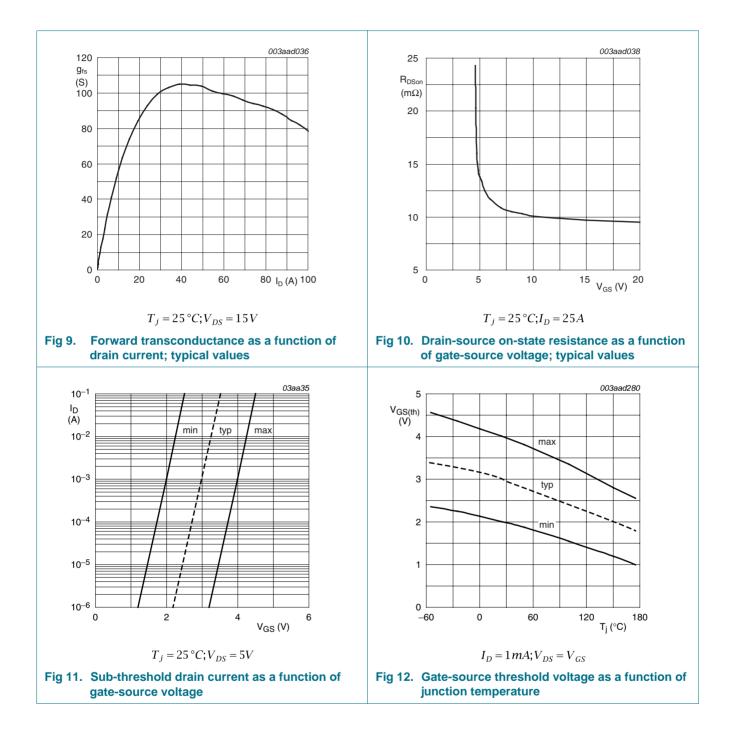
Fig 8. Input and reverse transfer capacitances as a function of gate-source voltage; typical values

PSMN012-80PS_2

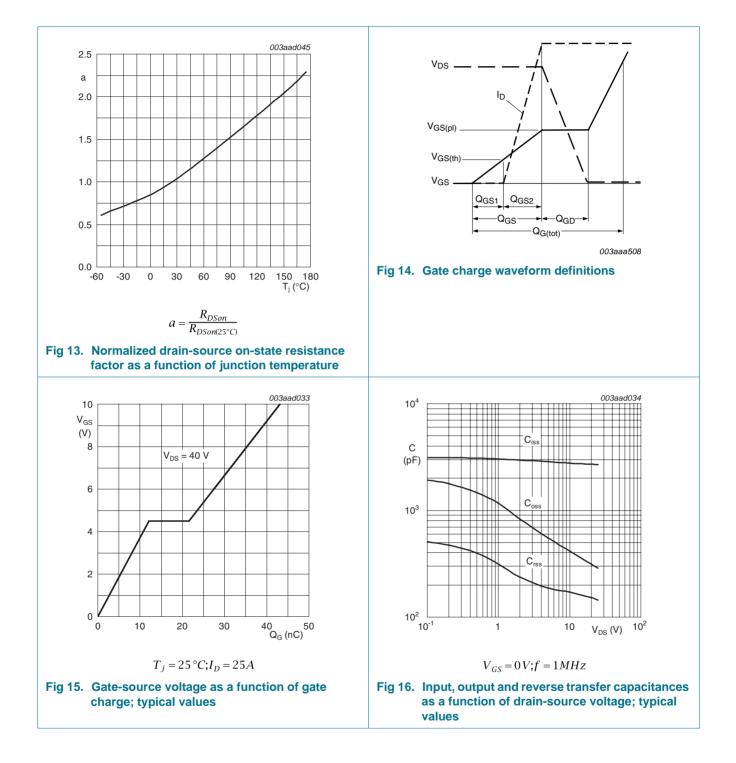
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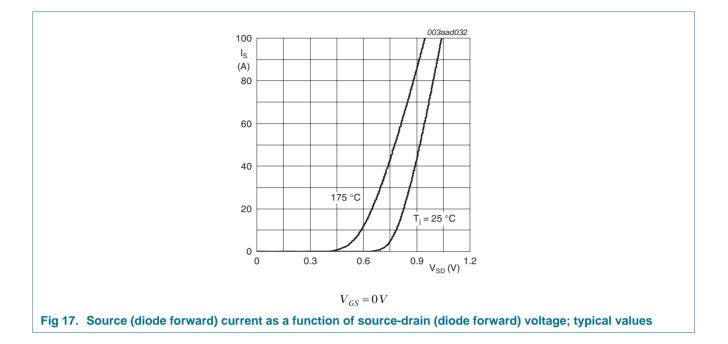
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7. Package outline

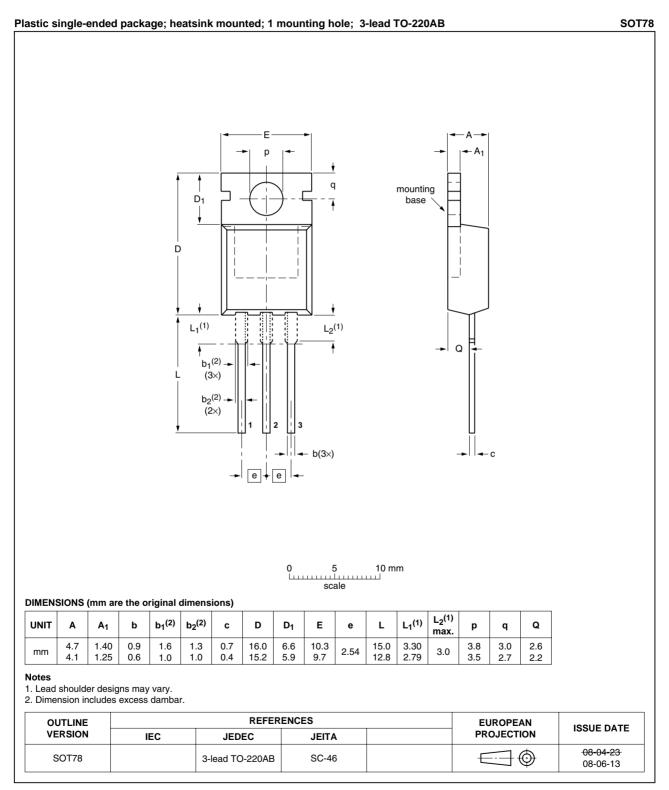


Fig 18. Package outline SOT78 (TO-220AB)

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8. Revision history

Table 7.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN012-80PS_2	20090625	Product data sheet	-	PSMN012-80PS_1
Modifications:	 Various cl 	nanges to content.		
PSMN012-80PS_1	20090609	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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N-channel 80 V 11 m Ω standard level MOSFET

11. Contents

1	Product profile1
1.1	General description1
1.2	Features and benefits1
1.3	Applications1
1.4	Quick reference data1
2	Pinning information2
3	Ordering information2
4	Limiting values3
5	Thermal characteristics4
6	Characteristics5
7	Package outline10
8	Revision history11
9	Legal information12
9.1	Data sheet status12
9.2	Definitions12
9.3	Disclaimers
9.4	Trademarks12
10	Contact information12

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